



Product Change Notification

Change Notification #: 118298-00
Change Title: Select Intel® Server System R2000WF Family,
PCN 119298-00, Product Material,
New components due to EOL
Date of Publication: June 07, 2021

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:*	June 18, 2021
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Due to End Of Life or the usage of an alternative source to secure inventory and improvement on the board's internal clock, Intel is replacing the following components on the items listed in the table products affected.

- U5B3 – Low voltage Translator
- Several Locations – Monolithic Ceramic Capacitor

Customer Impact of Change and Recommended Action:

Intel does not expect any other impact to customers from these changes but encourages customers to understand the change and determine the impact on their applications. For that reason, Intel recommends that the customer perform a standard level of evaluation.

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
Intel® Server System R2312WFTZSR	R2312WFTZSR	986053	K40015-009	H48104-873; H48104-883	K40015-010	H48104-950; H48104-960

PCN Revision History:

Date of Revision: June 07, 2021	Revision Number: 00	Reason: Originally Published PCN
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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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